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Part Number: [0545481171](#)
Status: **Active**
Overview: [ffc_fpc_smt](#)
Description: 0.50mm (.020") Pitch FFC/FPC Connector, 1.20mm (.047") Height, Right Angle, SMT, ZIF, Bottom Contact Style, 11 Circuits, Lead-free, Gold (Au) Plating

Documents:
[3D Model](#)
[Drawing \(PDF\)](#)

[Product Specification PS-54548-039 \(PDF\)](#)
[RoHS Certificate of Compliance \(PDF\)](#)

General

Product Family	FFC/FPC Connectors
Series	54548
Overview	ffc_fpc_smt
Product Name	N/A

Physical

Circuits (Loaded)	11
Contact Position	Bottom
Durability (mating cycles max)	20
Entry Angle	90° Angle
Mated Height (in)	0.047 In
Mated Height (mm)	1.20 mm
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Number of Rows	1
Orientation	Right Angle
PCB Locator	No
PCB Retention	Yes
Packaging Type	Embossed Tape on Reel
Pitch - Mating Interface (in)	0.020 In
Pitch - Mating Interface (mm)	0.50 mm
Polarized to PCB	Yes
Stackable	No
Temperature Range - Operating	-20°C to +85°C
Termination Interface: Style	Surface Mount
Wire/Cable Type	FFC/FPC

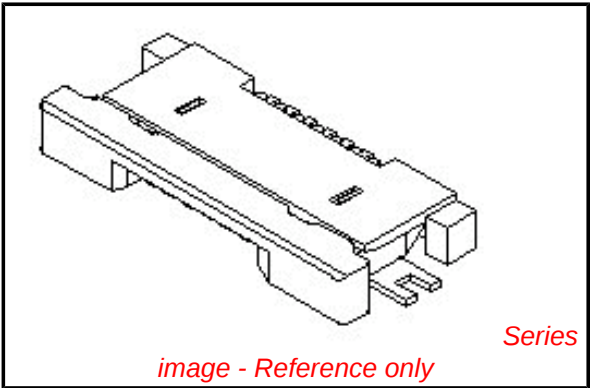
Electrical

Current - Maximum per Contact	0.5A
Voltage - Maximum	50V

Material Info

Reference - Drawing Numbers

Packaging Specification	SPK-54548-001
Product Specification	PS-54548-039, RPS-54548-097, RPS-54548-099
Sales Drawing	SD-54548-039, SD-54548-040



EU RoHS
ELV and RoHS
Compliant
REACH SVHC
Not Reviewed
Halogen-Free
Status
Not Reviewed

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series
[54548Series](#)

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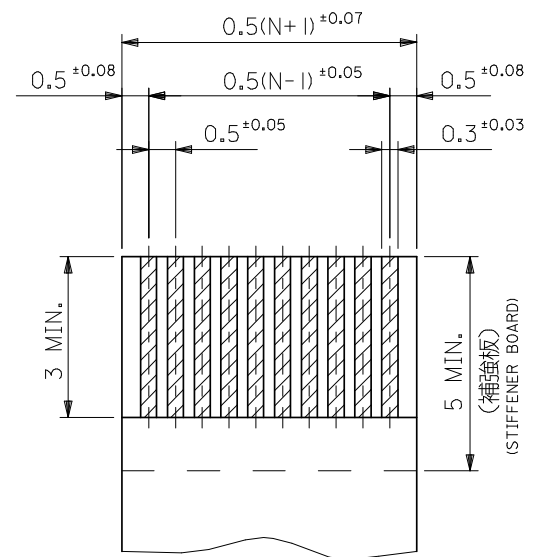
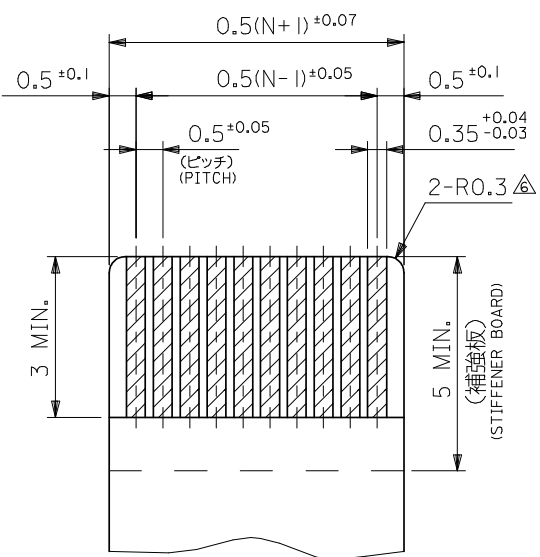
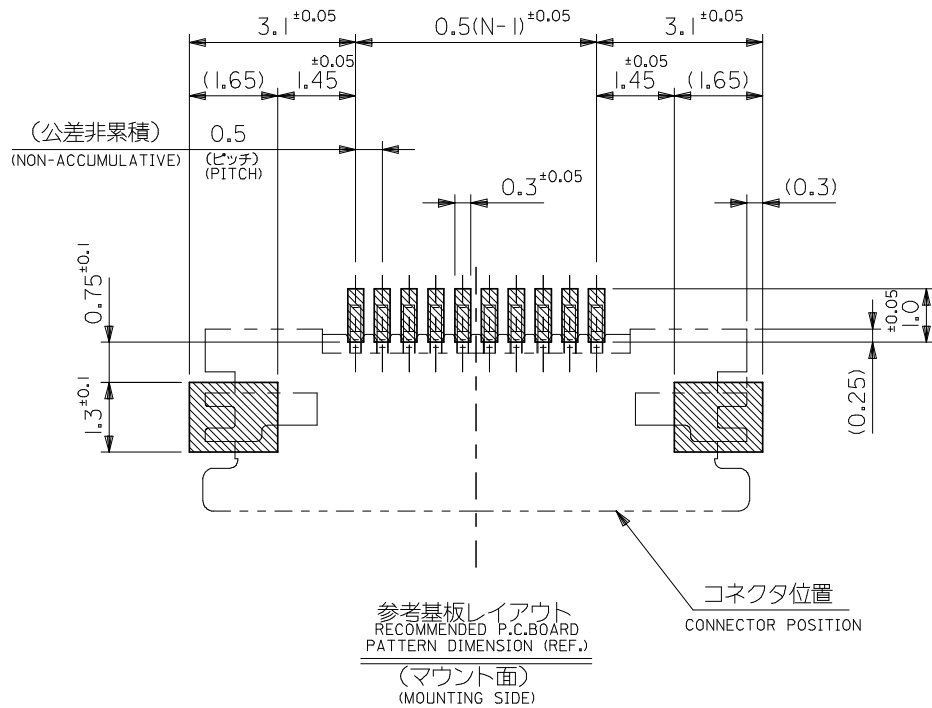
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適合FPC推奨寸法
APPLICABLE FPC
RECOMMENDED DIMENSION
(仕上がり厚さ: 表参照)
(THICKNESS: SEE CHART)

適合FFC推奨寸法
APPLICABLE FFC
RECOMMENDED DIMENSION
(仕上がり厚さ: 表参照)
(THICKNESS: SEE CHART)

注記 NOTES

I. 使用材料 MATERIAL

- ハウジング : LCP, UL94V-0
HOUSING
アクチュエータ : PPS, UL94V-0
ACTUATOR
ターミナル : リン青銅 (t=0.2)
TERMINAL PHOSPOR BRONZE
メッキ : 接点部: 金メッキ
PLATING CONTACT PORTION : GOLD PLATING
テール部: 鍍メッキ
SOLDERING PORTION : TIN OVER PLATING
下地: ニッケルメッキ
UNDER PLATING: NICKEL PLATING
金具 : リン青銅、鍍メッキ (t=0.2)
FITTING NAIL PHOSPOR BRONZE, TIN PLATING
下地: ニッケルメッキ
UNDER PLATING: NICKEL PLATING

- △ パターンはくり止め用金具
FITTING NAIL FOR PREVENTION OF PEELING
OF P.C.B. PATTERN.
△ RO.3はFPC導体部にかからないこと
RO.3 MUST NOT BE OVERLAPPED TO PATTERN OF FPC.
7. 本製品は54548-**-21の鉛フリー(部分金メッキ)品である。
THIS PRODUCT IS LEAD FREE OF 54548-**-21 (SELECTIVE GOLD).
8. N: 極数 N: CIRCUIT.

2. エンボステープ梱包時は、アクチュエータがロックした状態とする。
IN THE PACKAGE, ACTUATOR OF PART NO.54548-**-29 SHOULD BE LOCKED.
△ ソルダータール半田付け面のズレ量、及び金具半田付け面のズレ量は、基準面 Z
に対し上方向 0 MAX.、下方向 0.15 MAX.とし
相互のバツキ量は0.1 MAX.とする。
MISALIGNMENT OF SOLDER TAILS AND FITTING NAILS FROM Z
UPPER DIRECTION: 0 MAX., LOWER DIRECTION: 0.15 MAX.
OFFSET BETWEEN UPPER AND LOWER 0.1 MAX.
△ 偶数極に適用。
APPLY FOR EVEN CIRCUIT.

FPC/FFC について:

打ち抜き方向は導体側から補強板側を推奨します。
導体部については軟銅箔35μmまたは50μmを推奨します。
ABOUT FPC/FFC
RECOMMENDED PUNCHER DIRECTION : FROM CONDUCTOR SIDE TO STIFFENER FILM SIDE.
RECOMMENDED CONDUCTOR SPEC :
THICKNESS OF SOFT COPPER FOIL : 35 MICROMETER OR 50 MICROMETER.

FPC について:

補強フィルム材質はポリイミドを推奨します。ベースフィルムは25μmを推奨します。
接着剤は熱硬化接着剤を推奨します。
尚、接着剤の接点部への付着は導通不良の原因になりますので、染み出しが無い様、お願い致します。
ABOUT FPC
RECOMMENDED MATERIAL/THICKNESS.
STIFFENER FILM : POLYIMIDE
BASE FILM THICKNESS : 25μm
BONDING AGENT : THERMOSETTING BONDING AGENT
PLEASE PUT APPROPRIATE AMOUNT OF ADHESIVE ON THE CONTACT AREA BECAUSE THE EXTRA ADHESIVE MAY CAUSE THE DEFECT IN ELECTRICAL CONTINUITY.

REVISED EC NO: J2008-4048 DRWN:WABEI CHKD:THARUYAMA APPR:NUKITA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	20 THIRD ANGLE PROJECTION	MODEL NO.
		10 UNDER	±0.2	DRAWN BY HSHIMABUKURO	DATE '04/02/10	TITLE 0.5 FPC CONN ZIF HSG ASSY FOR SMT RA BTM CONT -LEAD FREE-			
		10 OVER 30 UNDER	±0.25	CHECKED BY KTOJO	DATE '04/02/10				
		30 OVER	±0.3	APPROVED BY MSASAO	DATE '04/02/10	molex MOLEX INCORPORATED			
		ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.			SHEET NO.
	REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 1		SD-54548-039			2 OF 2
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									

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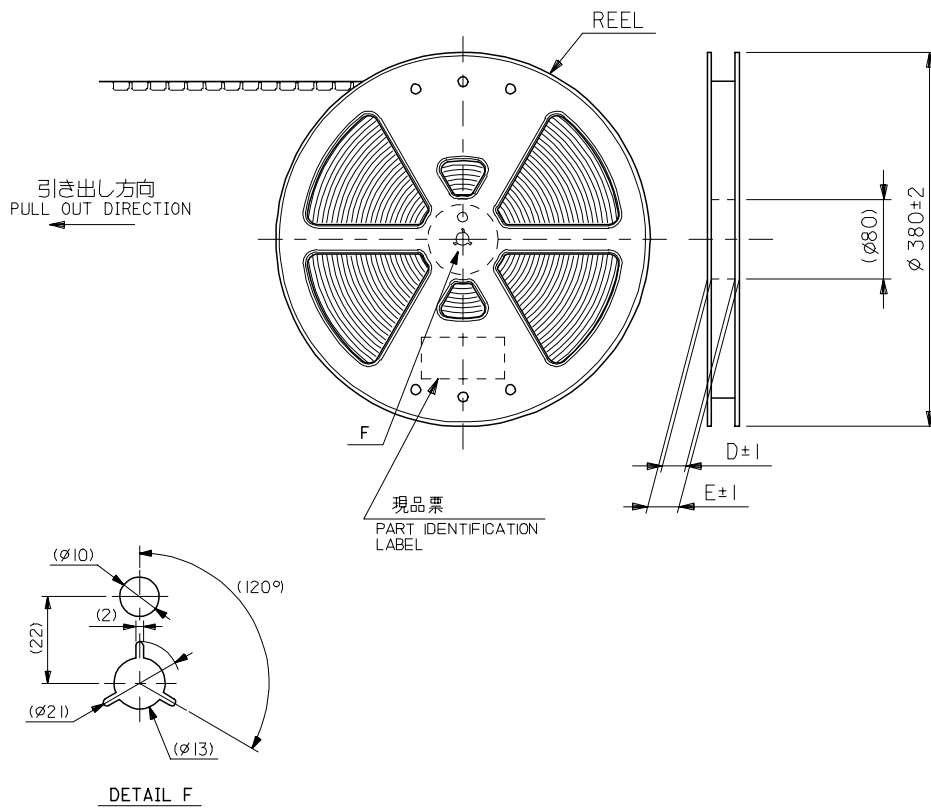
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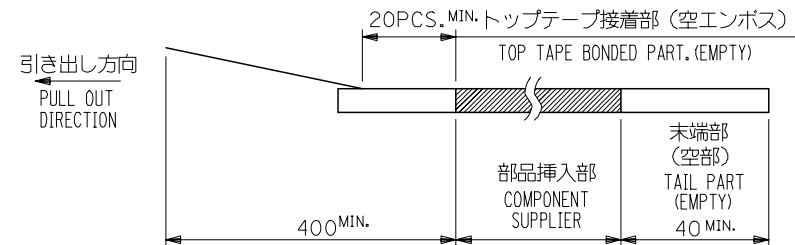
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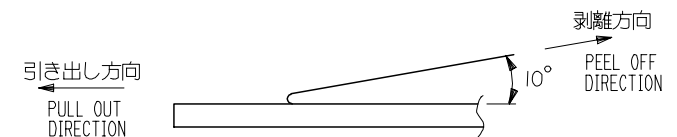


NOTES

- 製品詳細寸法については図面 SD-54548-039 を参照下さい。
RE DETAILED DIMENSION, SEE SD-54548-039
- 梱包数量：3000個/リール
NUMBER OF CONNECTORS : 3000PCS/REEL
- リードテープ長さ LEAD TAPE LENGTH

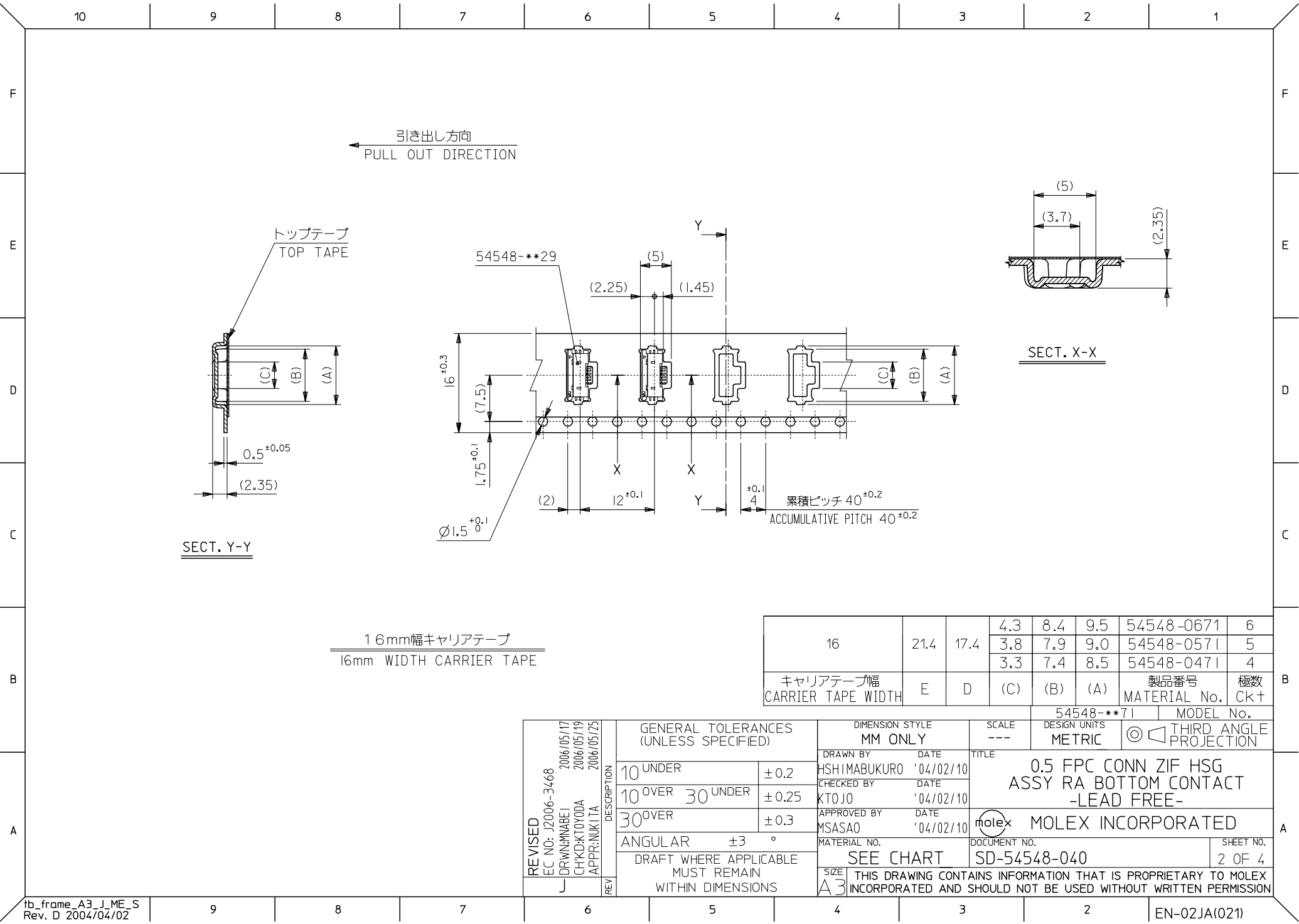


- トップテープの剥離強度：0.1N ～ 1.3N(10gf ～ 130gf)
(剥離方向は下図参照)
尚、本規格値は出荷時に適用。(但し、輸送時に剥離が発生しないこと。)
PEELING OFF FORCE OF TOP TAPE : 0.1N ～ 1.3N(10gf ～ 130gf)
(PEELING DIRECTION AS SHOWN IN FOLLOWING FIG.)
THIS REQUIREMENT SHOULD BE APPLIED AT SHIPMENT.
PEEL OFF SHOULD NOT BE ALLOWED , DURING TRANSPORTATION.



- 材料(MATERIAL)
キャリアテープ(CARRIER TAPE)：ポリプロピレン(POLYPROPYLENE)
トップテープ(TOPTAPE)：PET , PE , PEF
リール(REEL)：ポリスチレン (PS) <リサイクル材を含む>
POLYSTYRENE(PS) <RECYCLE MATERIAL CONTAINED>
- 本製品は 54548-**-91 の鉛フリー(部分金メッキ)品である。
THIS PRODUCT IS LEAD FREE OF 54548-**-91 (SELECTIVE GOLD).

REVISED EC NO: J2006-3468 DRAWN:MABE1 2006/05/17 CHKD:K TOYODA 2006/05/19 APPR:NIKI TA 2006/05/25		DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	54548-**71		MODEL No.	
					MM ONLY		---	DESIGN UNITS	 THIRD ANGLE PROJECTION		
			DRAWN BY DATE		TITLE						
			CHECKED BY DATE								
			APPROVED BY DATE		MOLEX MOLEX INCORPORATED						
MSASAO '04/02/10		MATERIAL NO.		DOCUMENT NO.		SHEET NO.					
SEE CHART		SD-54548-040		1 OF 4							
SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									







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